STARPOWER

SEMICONDUCTOR

IGBT

GD300HFL120C2S

Molding Type Module

1200V/300A 2 in one-package

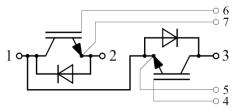
General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} SPT+ IGBT technology
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD300HFL120C2S	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	±20	V
ī	Collector Current @ T _C =25 ℃	460	Α.
I_{C}	@ T _C =100°C	300	A
I_{CM}	Pulsed Collector Current t _p =1ms	600	A
I_{F}	Diode Continuous Forward Current	300	A
I_{FM}	Diode Maximum Forward Current	600	A
P_D	Maximum Power Dissipation @ $T_j=175$ °C	1974	W
T_{j}	Maximum Junction Temperature	175	$^{\circ}\!\mathbb{C}$
$T_{ m jop}$	Operating Junction Temperature	-40 to +150	$^{\circ}\!\mathbb{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\!\mathbb{C}$
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000	V
Mounting Torque	Power Terminal Screw:M6	2.5 to 5.0	N.m
Mounting Torque	Mounting Screw:M6	3.0 to 5.0	N.m

Electrical Characteristics of IGBT $T_C=25\,^{\circ}\text{C}$ unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	T _j =25°C	1200			V
I _{CES}	Collector Cut-Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$ $T_{j}=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V,$ $T_{j}=25$ °C			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold	$I_{C}=12.0\text{mA}, V_{CE}=V_{GE},$	5.0	6.2	7.0	V
	Voltage	$T_j=25^{\circ}C$	5.0			
V _{CE(sat)}	Collector to Emitter	$I_{C}=300A, V_{GE}=15V,$		2.00	2.45	
		$T_j=25$ °C				N/
	Saturation Voltage	I _C =300A,V _{GE} =15V,		2.20]
		T _j =125℃				

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			574		ns
t _r	Rise Time			133		ns
t _{d(off)}	Turn-Off Delay Time	V (00VI 200A		563		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V,I_{C}=300A,$ $R_{G}=4.7\Omega,V_{GE}=\pm 15V,$		120		ns
Eon	Turn-On Switching Loss	$T_j=25^{\circ}C$		23.9		mJ
$E_{\rm off}$	Turn-Off Switching Loss			25.3		mJ
t _{d(on)}	Turn-On Delay Time			604		ns
t _r	Rise Time			137		ns
t _{d(off)}	Turn-Off Delay Time	V (00VI 200A		629		ns
$t_{\rm f}$	Fall Time	$\begin{array}{c} - & V_{CC} = 600 \text{V}, I_{C} = 300 \text{A}, \\ - & R_{G} = 4.7 \Omega, V_{GE} = \pm 15 \text{V}, \\ - & T_{j} = 125 ^{\circ}\text{C} \end{array}$		167		ns
Eon	Turn-On Switching Loss			31.5		mJ
E _{off}	Turn-Off Switching Loss			35.9		mJ
Cies	Input Capacitance			21.2		nF
Coes	Output Capacitance	V_{CE} =25V,f=1MHz, V_{GE} =0V		1.42		nF
C _{res}	Reverse Transfer Capacitance			0.94		nF
I_{SC}	SC Data	$t_{S^{C}} \le 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}\text{C}, V_{CC} = 900 V,$ $V_{CEM} \le 1200 V$		1800		A
R _{Gint}	Internal Gate Resistance			1.0		Ω
L _{CE}	Stray Inductance				20	nН
R _{CC'+EE'}	Module Lead Resistance, Terminal to Chip	T _C =25°C		0.35		mΩ

Electrical Characteristics of Diode $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I 200 A	T _j =25℃		1.82	2.25	V
	Voltage	$I_F = 300A$	T _j =125 ℃		1.95]
Qr	December of Change		T _j =25℃		20.2		C
	Recovered Charge	$I_F=300A,$	T _j =125 ℃		40.1		μC
I_{RM}	Peak Reverse	$V_R = 600V$,	T _j =25℃		170		
	Recovery Current	di/dt=-2360A/μs,	T _j =125 ℃		250		A
E_{rec}	Reverse Recovery	$V_{GE}=-15V$	T _j =25℃		8.2		I
	Energy		T _j =125 ℃		21.7		mJ

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case (per IGBT)		0.076	K/W
$R_{ heta JC}$	Junction-to-Case (per Diode)		0.100	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.035		K/W
Weight	Weight of Module	300		g

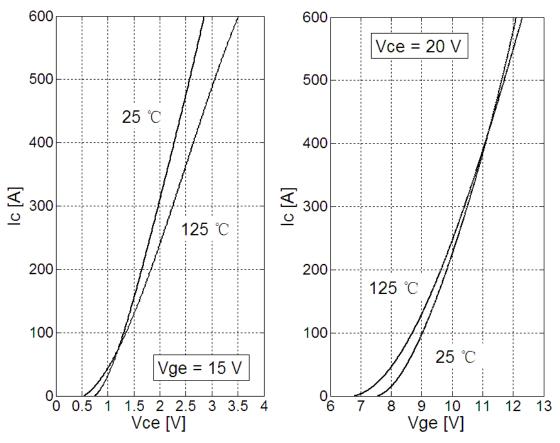


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

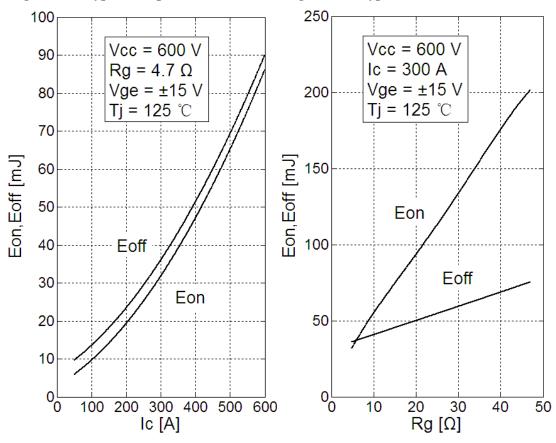


Fig 3. IGBT Switching Loss vs. I_C

Fig 4. IGBT Switching Loss vs. $R_{\rm G}\,$

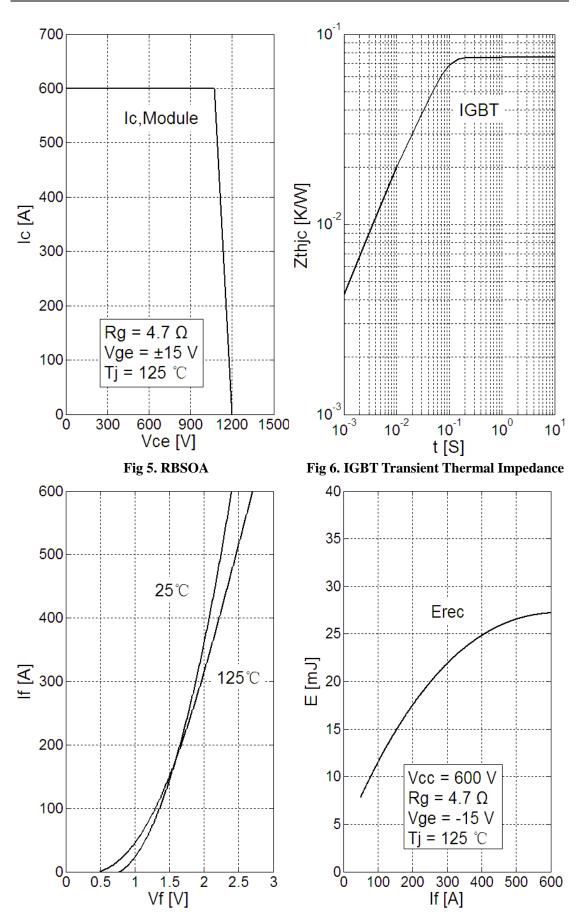


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs. $I_{\rm F}\,$

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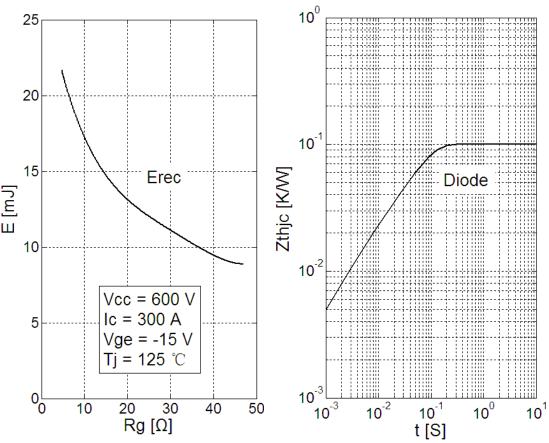
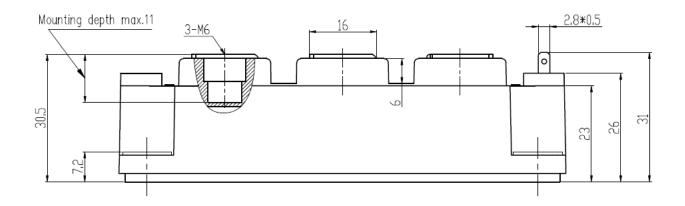


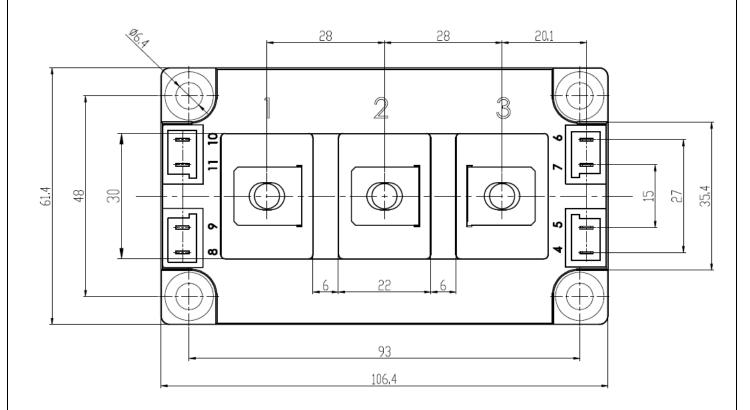
Fig 9. Diode Switching Loss vs. $R_{\rm G}$

Fig 10. Diode Transient Thermal Impedance

Package Dimension

Dimensions in Millimeters





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